

60V N-Channel Trench MOSFET

FEATURES

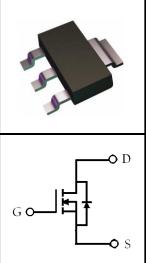
- Trench Power MOSFET Technology
- Low RDS(ON)
- Low Gate Charge
- Optimized For Fast-switching Applications

APPLICATIONS

- High frequency DC-DC converters
- Power switching application

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Device Marking and Package Information				
Device	Marking			
CTQ06N085	SOT223	602		

Absolute Maximum Ratings at $T_j = 25^{\circ}C$ unless otherwise noted				
Parameter		Symbol	Value	Unit
Drain-Source Voltage ($V_{GS} = 0V$)		V_{DSS}	60	V
Continuous Drain Current $T_c = 25^{\circ}C$	(note1)	-	5	А
Continuous Drain Current $T_c = 100^{\circ}C$	(note1)	Ι _D	4	А
Pulsed Drain Current	(note2)	I _{DM}	12	А
Gate Source Voltage		V_{GSS}	±20	V
Power Dissipation $T_{C} = 25^{\circ}C$	(note4)	P _D	1.25	W
Operating Junction and Storage Temperature Range		T _J , T _{stg}	-55~+175	°C

Thermal Characteristics					
Parameter		Symbol	Value	Unit	
Thermal Resistance, Junction-to-Case	(note1)	$R_{ extsf{ heta}JC}$	80	°C/W	
Thermal Resistance, Junction-to-Ambient	(note1)	$R_{ extsf{ heta}JA}$	95		



CTQ06N085

Electrical Characteristics T_j = 25°C unless otherwise specified							
Parameter	Symbol		Value				
		Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V _{(BR)DSS}	$V_{GS} = 0V, I_D = 250\mu A$	60			V	
Zero Gate Voltage Drain Current		$V_{DS} = 60V, V_{GS} = 0V, T_{J} = 25^{\circ}C$			1	uA	
	I _{DSS}	$V_{DS} = 60V, V_{GS} = 0V, T_{J} = 55^{\circ}C$			5	uA	
Gate-Source Leakage	I _{GSS}	$V_{GS} = \pm 20 V$		-	±100	nA	
Gate-Source Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250 \mu A$	1.2	1.6	2.5	V	
Drain-Source On-Resistance (note2)	5	$V_{GS} = 10V, I_D = 3A$		65	85	mΩ	
	R _{DS(on)}	$V_{GS} = 4.5 V, I_{D} = 2 A$		75	100	mΩ	
		Dynamic					
Input Capacitance	C _{iss}	$V_{GS} = 0V,$ $V_{DS} = 12V,$ f = 1.0MHz		695		pF	
Output Capacitance	C _{oss}			148			
Reverse Transfer Capacitance	C _{rss}			7			
Total Gate Charge (4.5V)	Q_{g}	$V_{DS} = 15V, I_D = 1A,$ $V_{GS} = 10V$		5.5			
Gate-Source Charge	Q_gs			1.8		nC	
Gate-Drain Charge	Q_{gd}			2.4			
Turn-on Delay Time	t _{d(on)}	$V_{DS} = 12V, I_D = 5A$, $R_G = 3.3\Omega, V_{GS} = 10V$		6			
Turn-on Rise Time	t _r			10		ns	
Turn-off Delay Time	t _{d(off)}			15			
Turn-off Fall Time	t _f			7			
Body Diode Characteristics							
Source-Drain Current(Body Diode)	۱ _s				5	А	
Pulsed Source-Drain Current(Body Diode)	I _{SDM}	1			12		
Body Diode Voltage	V _{SD}	$T_{J} = 25^{\circ}C, I_{SD} = 1A, V_{GS} = 0V$			1.2	V	

Notes

1. The data tested by surface mounted on a 1 inch2 FR-4 board with 2OZ copper.

2. The data tested by pulsed , pulse width $\!\!\!\leq\!\!300 us$, duty cycle $\!\!\!\leq\!\!2\%$

3. The EAS data shows Max. rating . The test condition is VDD =25V, VGS =10V, L=0.1mH

4. The power dissipation is limited by 175°C junction temperature

5. The data is theoretically the same as ID and IDM, in real applications, should be limited by total power dissipation.



Typical Characteristics $T_J = 25^{\circ}C$, unless otherwise noted

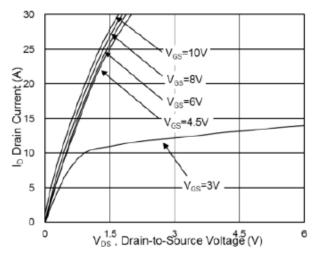


Fig.1 Typical Output Characteristics

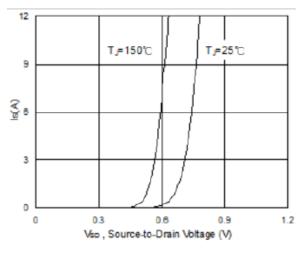


Fig.3 Source Drain Forward Characteristics

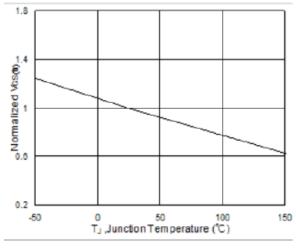


Fig.5 Normalized V GS(th) vs. T J

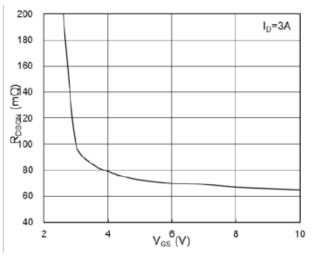


Fig.2 On-Resistance vs. G-S Voltage

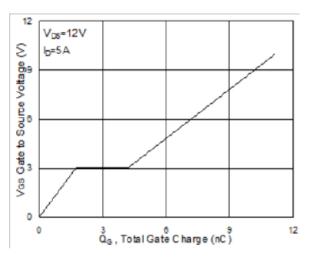
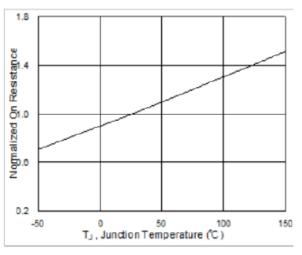
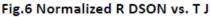


Fig.4 Gate-Charge Characteristics







Typical Characteristics $T_J = 25^{\circ}C$, unless otherwise noted

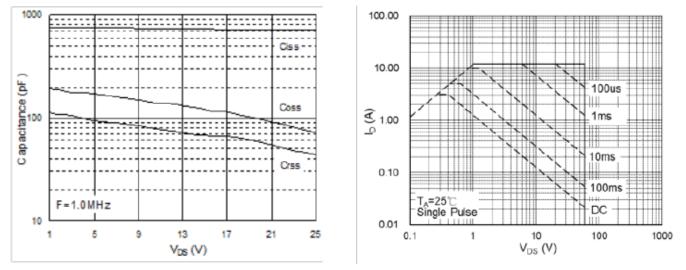


Fig.7 Capacitance

Fig.8 Safe Operating Area

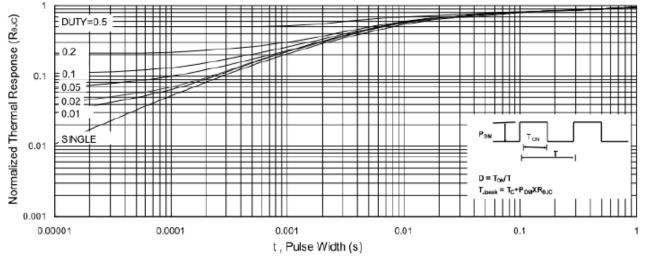


Fig.9 Normalized Maximum Transient Thermal Impedance





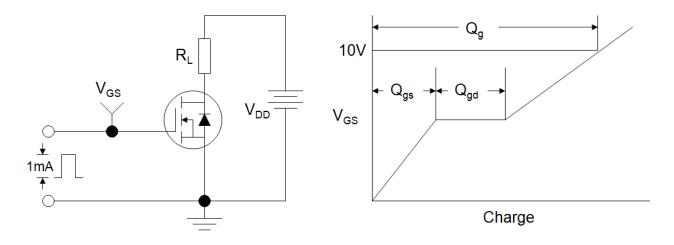


Figure B: Resistive Switching Test Circuit and Waveform

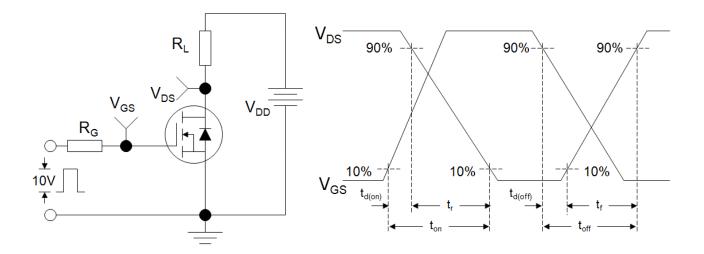
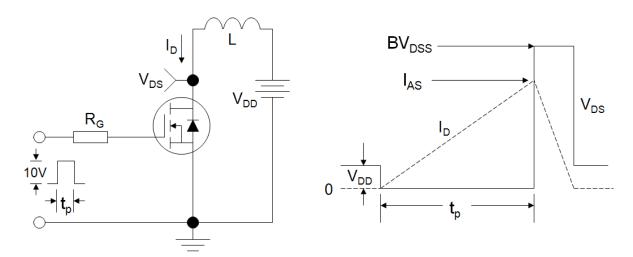


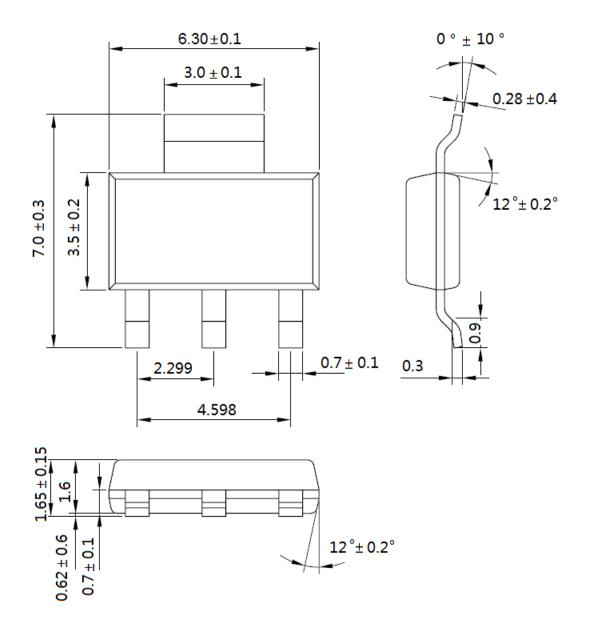
Figure C: Unclamped Inductive Switching Test Circuit and Waveform







SOT223





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